

MAX33040E/MAX33041E

Click here to ask an associate for production status of specific part numbers.

+3.3V, 5Mbps CAN Transceiver with ±40V Fault Protection, ±25V CMR, and ±40kV ESD in 8-Pin SOT23

Benefits and Features

- Integrated Protection Increases Robustness
 - Increased Protection on CANH and CANL
 - ±40V Fault Tolerant
 - ±40kV ESD Human Body Model (HBM) Protection
 - ±25V Extended Common-Mode Input Range (CMR)
 - · Short-Circuit Protection
 - · Transmitter Dominant Timeout Prevents Lockup
 - · Thermal Shutdown
- Family Provides Flexible Design Options
 - · Slow Slew Rate to Minimize EMI
 - · Low-Current Standby Mode
- Small Package Options to Save PCB Area
 - 8-Bump WLP
 - 8-Pin SOT23
 - 8-Pin SOIC
- High-Speed Operation of up to 5Mbps
- Operating Temperature Range of -40°C to +125°C

General Description

The MAX33040E/MAX33041E are +3.3V control area network (CAN) transceivers with integrated protection for industrial applications. These devices have extended ±40V fault protection on CANH and CANL for equipment where overvoltage protection is required. They also incorporate high ±40kV ESD HBM and an input common-mode range (CMR) of ±25V on CANH and CANL, exceeding the ISO 11898-2 CAN standard of -2V to +7V. This makes these parts well suited for applications where there is moderate electrical noise that can influence the ground levels between two nodes or systems. These parts feature a shutdown pin and a multifunction standby pin.

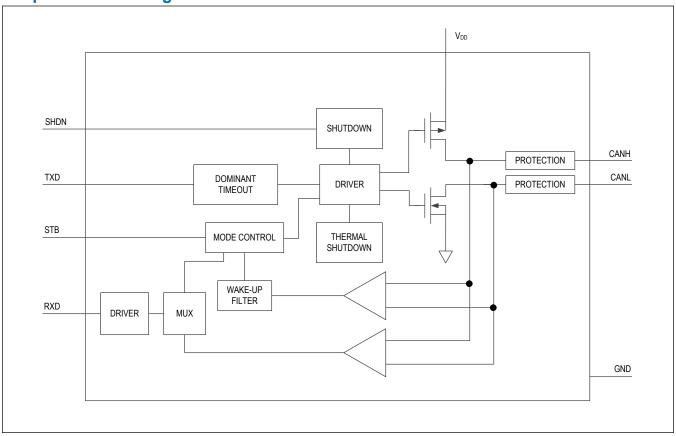
These devices operate at a high-speed CAN data rate, allowing up to 5Mbps on short distance networks. Maximum speed on large networks may be limited by the number of nodes, the type of cabling used, stub length, and other factors. The MAX33040E/MAX33041E include a dominant timeout to prevent bus lockup caused by controller error or by a fault on the TXD input. When TXD remains in the dominant state (low) for longer than t_{DOM} , the driver is switched to the recessive state, releasing the bus and allowing other nodes to communicate. These devices feature a STBY pin for three modes of operation; standby mode for low current consumption, normal high-speed mode, or a slow slew-rate mode when an external 39.2k Ω resistor is connected between ground and STBY pin.

The MAX33040E is available in an 8-bump WLP and 8-pin SOT23, while the MAX33041E is available in an 8-pin SOIC package. Both parts operate over the -40°C to +125°C temperature range.

Applications

- Industrial Equipment
- Instrumentation
- Motor Control
- Building Automation
- Industrial Drone
- Service and Educational Robot

Simplified Block Diagram



MAX33040E/MAX33041E

+3.3V, 5Mbps CAN Transceiver with ±40V Fault Protection, ±25V CMR, and ±40kV ESD in 8-Pin SOT23

Absolute Maximum Ratings

V _{DD} 0.3V to +4	4.0V Continuous Power Dissipation (SOIC)
CANH or CANL (Continuous)40V to +4	40V Multilayer Board ($T_A = +70^{\circ}C$, derate 7.4mW/°C above
TXD, STBY, SHDN0.3V to +4	4.0V +70°C.)588.2mW
RXD0.3V to +4	4.0V Operating Temperature Range40°C to +125°C
Short-Circuit Duration	ious Junction Temperature+150°C
Continuous Power Dissipation (SOT23)	Storage Temperature Range60°C to +150°C
Multilayer Board (T _A = +70°C, derate 9.5mW/°C ab	pove Soldering Temperature (reflow)+260°C
+70°C.)	

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Package Information

8 WLP

Package Code	W80A1+1
Outline Number	<u>21-1042</u>
Land Pattern Number	See Application Note 1891
Thermal Resistance, Four Layer Board:	
Junction-to-Ambient (θ _{JA})	85°C/W
Junction-to-Case Thermal Resistance (θ _{JC})	N/A

8 SOT23

Package Code	K8CN+2C			
Outline Number	<u>21-0078</u>			
Land Pattern Number	<u>90-0176</u>			
Thermal Resistance, Four Layer Board:				
Junction-to-Ambient (θ _{JA})	105°C/W			
Junction-to-Case Thermal Resistance (θ _{JC})	42.3°C/W			

8 SOIC

Package Code	S8+2C				
Outline Number	<u>21-0041</u>				
Land Pattern Number	90-0096				
Thermal Resistance, Four-Layer Board:					
Junction-to-Ambient (θ _{JA})	136°C/W				
Junction-to-Case Thermal Resistance (θ_{JC})	38°C/W				

For the latest package outline information and land patterns (footprints), go to www.maximintegrated.com/packages. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

Package thermal resistances were obtained using the method described in JEDEC specification JESD51-7, using a four-layer board. For detailed information on package thermal considerations, refer to www.maximintegrated.com/thermal-tutorial.

Electrical Characteristics

 $(V_{DD}$ = 3.0V to 3.6V, R_{LD} = 60 Ω , C_{LD} = 100pF, C_L = 15pF, T_A = T_{MIN} to T_{MAX} , unless otherwise specified. Typical values are at V_{DD} = 3.3V and T_A = +25°C, unless otherwise specified. (Note 1))

PARAMETER	SYMBOL	COND	CONDITIONS		TYP	MAX	UNITS	
POWER								
Supply Voltage	V_{DD}			3.0		3.6	V	
Dominant Supply		TXD = SHDN =	No load		4.5	8		
Current	I _{DD} DOM	STBY = 0V, RXD open	R _{LD} = 60Ω		36	50	mA	
Recessive Supply	lpp pro	V _{DD} = TXD = 3.3V, STBY = SHDN = 0V, RXD open	No load		3.6		- mA	
Current	I _{DD_REC}	V _{DD} = TXD = 3.3V, STBY = SHDN = 0V, RXD open	CANH shorted to CANL		3.6		IIIA	
Shutdown Current	I _{SHDN}	SHDN = STBY = TX	D = V _{DD}			5	μA	
Standby Supply Current	I _{STBY}	STBY = TXD = V _{DD} , open	SHDN = 0V, RXD			60	μА	
UVLO Threshold Rising	V _{UVLO_R}	V _{DD} rising				2.7	V	
UVLO Threshold Falling	V _{UVLO_F}	V _{DD} falling		1.2			V	
FAULT PROTECTION								
ESD Protection (CANH,		Human Body Model (HBM), JEDEC JS-001-2017			±40		kV	
CANL to GND)		Air-Gap ISO 10605, IEC 61000-4-2			±15			
		Contact ISO 10605, IEC 61000-4-2			±10			
ESD Protection (All Other Pins)		Human Body Model		±4		kV		
Fault Protection Range	V _{FP}	CANH or CANL to G	ND	-40		+40	V	
Thermal Shutdown	T _{SHDN}				+160		°C	
Thermal Shutdown Hysteresis	T _{HYST}				+20		°C	
LOGIC INTERFACE (RXI), TXD, STBY, S	SHDN)						
Input High Voltage	V_{IH}			2			V	
Input Low Voltage	V_{IL}					0.8	V	
TXD Input Pullup Resistance	R _{PU_TXD}	TXD = 0V		100		250	kΩ	
STBY Input Pullup Resistance	R _{PU_STBY}	STBY = 0V	100		250	kΩ		
Slow Slew Rate Resistor	R _{SLEW_ON}	External resistor size ground to enable slo		39.2		kΩ		
SHDN Input Pulldown Resistance	R _{PD_SHDN}	SHDN = V _{DD}	1			МΩ		
Output High Voltage	V _{OH}	Sourcing 4mA, TXD	0.8 x V _{DD}			V		
Output Low Voltage	V _{OL}	Sinking 4mA, TXD = 0V				0.4	V	
Input Low Voltage STBY	V _{IL_STBY}					0.2	V	

Electrical Characteristics (continued)

 $(V_{DD}$ = 3.0V to 3.6V, R_{LD} = 60 Ω , C_{LD} = 100pF, C_L = 15pF, T_A = T_{MIN} to T_{MAX} , unless otherwise specified. Typical values are at V_{DD} = 3.3V and T_A = +25°C, unless otherwise specified. (Note 1))

PARAMETER	SYMBOL	COND	ITIONS	MIN	TYP	MAX	UNITS
CAN BUS DRIVER	1			•			
Bus Output Voltage	.,	1 1 TVD = 0\(\frac{1}{2}\)	CANH	2.25		V _{DD}	V
(Dominant)	V _{O_DOM}	$t < t_{DOM}$, TXD = 0V	CANL	0.5		1.25	
Bus Output Voltage	.,	TXD = V _{DD} , No	CANH	1		2	V
(Recessive)	Vo_REC	load	CANL	1		2	V
Bus Output Differential Voltage (Dominant)	V _{OD_DOM}	TXD = 0V	$R_{CM} = 1K\Omega$, $-5V \le V_{CM} \le V_{DD}$, <u>Figure 1</u>	1.5		3	V
			R _{CM} = open	1.5		3	
Output Voltage Standby	V _{O_STBY}	$TXD = STBY = V_{DD}$	no load	40		120	mV
Bus Output Differential	V _{OD_REC}	TXD = V _{DD}	$R_{LD} = 60\Omega$	-10		+10	mV
Voltage (Recessive)	VOD_REC	170 - 400	No load	-50		+50	111.0
Short-Circuit Current	I _{SC_CANH}	TXD = 0V, CANH = -	40V		2	5	mA
Onort Onealt Ourient	I _{SC_CANL}	TXD = 0V, CANL = +	-40V		2	5	111/-X
RECEIVER							
Common-Mode Input Range	V _{CM}	CANH or CANL to G valid	ND, RXD output	-25		+25	V
Common-Mode Input Range Standby Mode	V _{CM_STBY}	CANH or CANL to G valid	ND, RXD output	-12		+12	V
Input Differential Voltage (Dominant)	V _{ID_DOM}	$-25V \le V_{CM} \le +25V$,	TXD = V _{DD}			0.9	V
Input Differential Voltage (Recessive)	V _{ID_REC}	-25V ≤ V _{CM} ≤ +25V,	0.5			V	
Standby Input Differential Voltage (Dominant)	V _{ID} STBYDOM	-12V ≤ V _{CM} ≤ +12V,			1.15	V	
Standby Input Differential Voltage (Recessive)	V _{ID_STBYREC}	-12V ≤ V _{CM} ≤ +12V,	TXD = V _{DD}	0.45			V
Input Differential Hysteresis	V _{ID_HYS}	-25V ≤ V _{CM} ≤ +25V			90		mV
Input Resistance	R _{IN}	$TXD = V_{DD}$		10		50	kΩ
Differential Input Resistance	R _{IN_DIFF}	$TXD = V_{DD}$		20		100	kΩ
Input Capacitance	C _{IN}	$TXD = V_{DD}$ (Note 2)		19	35	pF	
Differential Input Capacitance	C _{IN_DIFF}	$TXD = V_{DD} $ (Note 2)		10	18	pF	
Input Leakage Current	I _{LKG}	V _{DD} = 0V, CANH = 0		100	220	μA	
SWITCHING	-						•
		David and a	V _{STBY} = 0V		20		
Driver Rise Time	t _R	R _{CM} = open, Figure 1	39.2kΩ resistor from STBY to GND		100		ns

Electrical Characteristics (continued)

 $(V_{DD}$ = 3.0V to 3.6V, R_{LD} = 60 Ω , C_{LD} = 100pF, C_L = 15pF, T_A = T_{MIN} to T_{MAX} , unless otherwise specified. Typical values are at V_{DD} = 3.3V and T_A = +25°C, unless otherwise specified. (Note 1))

PARAMETER	SYMBOL	COND	ITIONS	MIN	TYP	MAX	UNITS	
			V _{STBY} = 0V		25			
Driver Fall Time	t _F	R _{CM} = open, Figure 1	39.2kΩ resistor from STBY to GND		100		ns	
TXD to RXD Loop Delay	t _{LOOP}	STBY = 0V	Dominant-to Recessive, Figure 2		70	140	ns	
			Recessive-to- Dominant, Figure 2		90	140		
TXD Propagation Delay (Recessive to Dominant)	tontxd	V_{DD} = 3.3V, R_{CM} is	open, <u>Figure 1</u>		43	60	ns	
TXD Propagation Delay (Dominant to Recessive)	tofftxd	V_{DD} = 3.3V, R_{CM} is		40	60	ns		
RXD Propagation Delay (Recessive to Dominant)	tonrxd	V _{DD} = 3.3V, C _L = 15		55	85	ns		
RXD Propagation Delay (Dominant to Recessive)	toffrxd	V _{DD} = 3.3V, C _L = 15pF, <u>Figure 3</u>			45	85	ns	
TXD-Dominant Timeout	t _{DOM}	Figure 4		1.3		4.3	ms	
Wake-Up Time	t _{WAKE}	Figure 5			2.3		μs	
Standby Propagation Delay (Dominant to Recessive)	^t PLH_STBY	STBY = V _{DD} , <u>Figure 5</u>			400		ns	
Standby to Normal Mode Delay	t _{D_STBYN}	C _L = 15pF, <u>Figure 6</u>			20		μs	
Normal to Standby Dominant Delay	t _{D_NSTBY}	C _L = 15pF, <u>Figure 6</u>			30		μs	
Shutdown to Normal Delay	t _{D_} SHDNN	C _L = 15pF, <u>Figure 7</u>			25		μs	

Note 1: All units are 100% production tested at $T_A = +25$ °C. Specifications over temperature are guaranteed by design.

Note 2: Not production tested. Guaranteed at $T_A = +25$ °C.

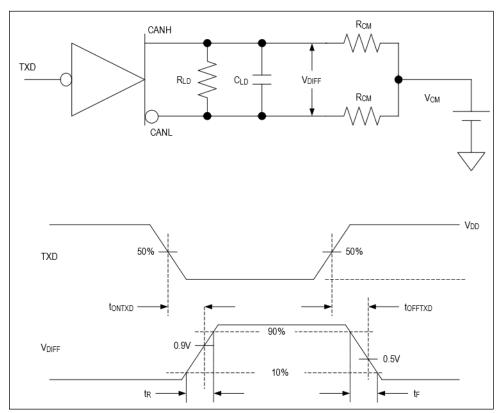


Figure 1. Transmitter Test Circuit and Timing Diagram

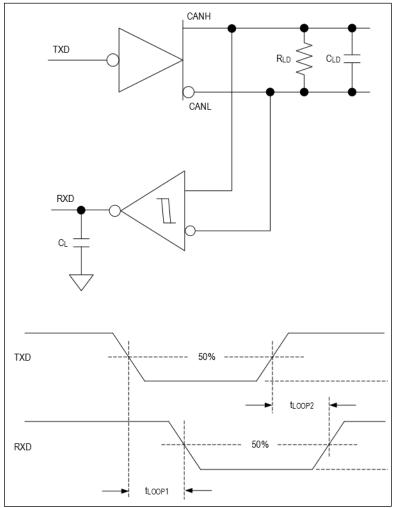


Figure 2. TXD to RXD Loop Delay

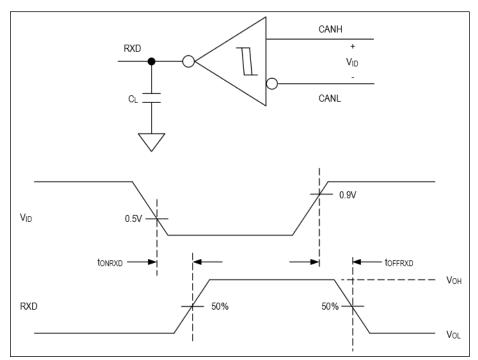


Figure 3. RXD Timing Diagram

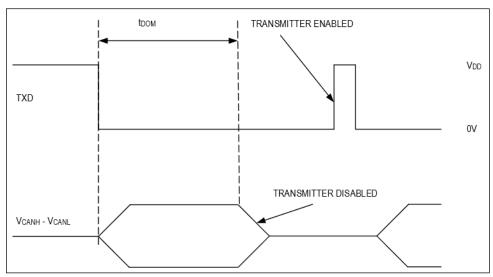


Figure 4. Transmitter-Dominant Timeout Timing Diagram

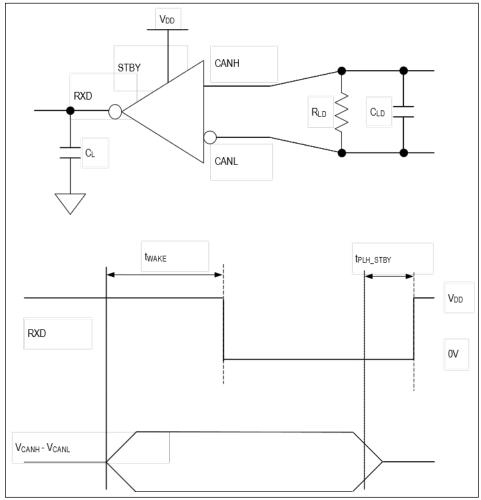


Figure 5. Standby Receiver Propagation Delay

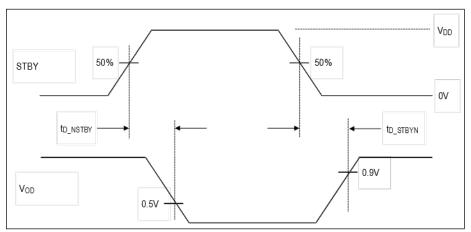


Figure 6. Standby Mode Timing Diagram

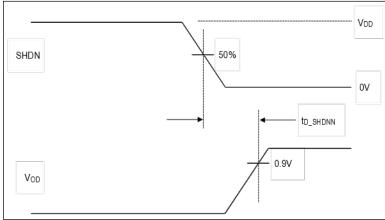
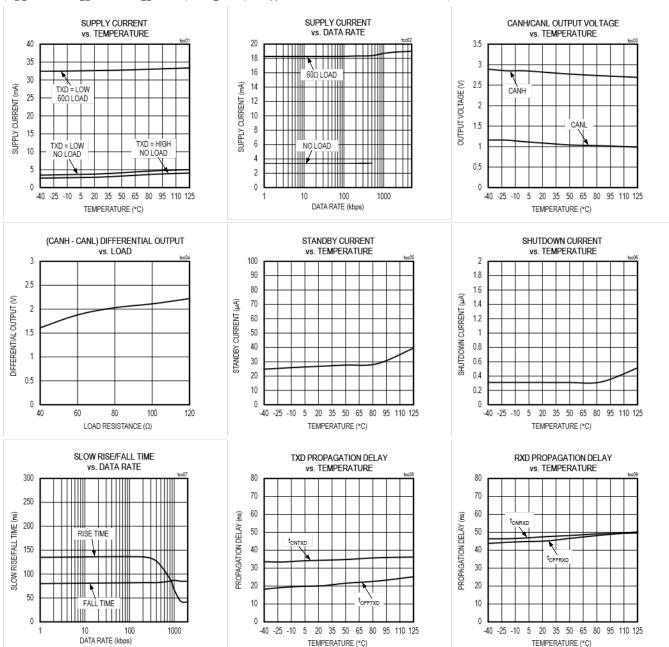


Figure 7. Shutdown Mode Timing Diagram

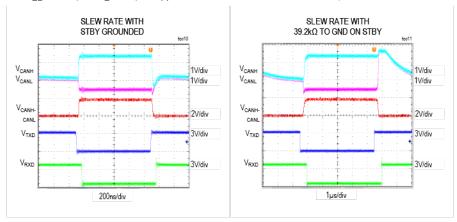
Typical Operating Characteristics

 $(V_{DD} = 3.3V, R_{LD} = 60\Omega, C_{LD} = 100pF, C_{L} = 15pF, T_{A} = +25^{\circ}C, unless otherwise noted.)$



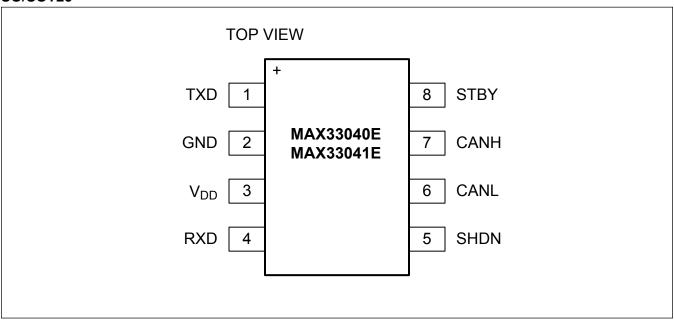
Typical Operating Characteristics (continued)

 $(V_{DD} = 3.3V, R_{LD} = 60\Omega, C_{LD} = 100pF, C_{L} = 15pF, T_{A} = +25^{\circ}C, unless otherwise noted.)$

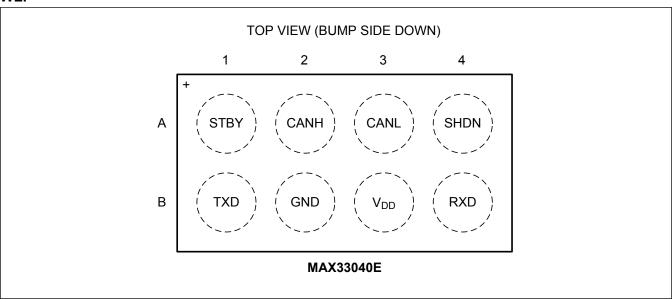


Pin Configurations

SO/SOT23



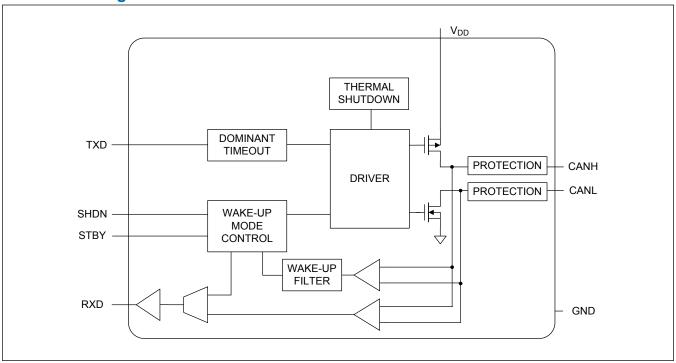
WLP



Pin Description

	11.1					
PIN		NAME	FUNCTION			
SO/SOT23	WLP	NAME	TONOTION			
1	B1	TXD	Transmit Data Input. Drive TXD high to set the driver in the recessive state. Drive TXD low to set the driver in the dominant state. TXD has an internal pullup to V_{DD} .			
2	B2	GND	Ground.			
3	В3	V _{DD}	Supply Voltage. Bypass V _{DD} to GND with a 0.1µF capacitor.			
4	B4	RXD	Receive Data Output. RXD is high when CANH and CANL are in the recessive state. RXD is low when CANH and CANL are in the dominant state.			
5	A4	SHDN	Shutdown Input, CMOS/TTL compatible. Drive SHDN high to put MAX33040E/MAX33041E in shutdown. SHDN has an internal pulldown resistor to GND.			
6	A3	CANL	CAN Bus-Line Low			
7	A2	CANH	CAN Bus-Line High			
8	A1	STBY	Standby Mode. A logic-high on STBY pin selects the standby mode. In standby mode, the transceiver is not able to transmit data and the receiver is in low power mode. A logic-low on STBY pin puts the transceiver in normal operating mode. A $39.2k\Omega$ external resistor can be used to connect the STBY pin to ground for slow slew rate.			

Functional Diagram



Detailed Description

The MAX33040E/MAX33041E are fault-protected CAN transceivers designed for industrial applications with a number of integrated robust protection feature set. These devices provide a link between the CAN protocol controller and the physical wires of the bus lines in a CAN. They can be used for DeviceNet™ applications as well.

These CAN transceivers are fault-protected on CANH and CANL up to ±40V, making it suitable for applications where overvoltage protection is required. These devices are rated up to a high ±40kV HBM ESD on CANH and CANL, suitable for protection during the manufacturing process, and even in the field where there is human interface for installation and maintenance. In addition, a common-mode voltage of ±25V enables communication in noisy environments where there are ground plane differences between different systems due to close proximity of heavy equipment machinery or operation from different transformers. The devices' dominant timeout prevents the bus from being blocked by a hung-up microcontroller, and the outputs CANH and CANL are short-circuit, current-limited, and are protected against excessive power dissipation by thermal shutdown circuitry that places the driver outputs in a high-impedance state.

These devices can operate up to 5Mbps with a standby mode where it shuts off the transmitter and reduces the current to 30µA (typ).

±40V Fault Protection

These devices feature ±40V of fault protection. CANH and CANL data lines are capable of withstanding a short from -40V to +40V. This extended overvoltage range makes it suitable for applications where accidental shorts to power supply lines are possible due to human intervention.

Transmitter

The transmitter converts a single-ended input signal (TXD) from the local CAN controller to differential outputs for the bus lines CANH and CANL. The truth table for the transmitter and receiver is provided in Table 1.

Transmitter Output Protection

The MAX33040E/MAX33041E protects the transmitter output stage against a short-circuit to a positive or negative voltage by limiting the driver current. Thermal shutdown further protects the devices from excessive temperatures that may result from a short or high ambient temperature. The transmitter returns to normal operation once the temperature is lowered below the threshold.

Transmitter-Dominant Timeout

The devices feature a transmitter dominant timeout (t_{DOM}) that prevents erroneous CAN controllers from clamping the bus to a dominant level by maintaining a continuous low TXD signal. When TXD remains in the dominant state (low) for greater than 2.5ms typical t_{DOM} , the transmitter is disabled, releasing the bus to a recessive state (<u>Figure 4</u>). After a dominant timeout fault, the transmitter is re-enabled when receiving a rising edge at TXD. The transmitter dominant timeout limits the minimum possible data rate to 9kbps for standard CAN protocol.

Receiver

The receiver reads the differential input from the bus line CANH and CANL and transfers this data as a single-ended output RXD to the CAN controller. It consists of a comparator that senses the difference V_{DIFF} = (CANH-CANL), with respect to an internal threshold of 0.7V. If V_{DIFF} > 0.9V, a logic-low is present on RXD. If V_{DIFF} < 0.5V, a logic-high is present. The CANH and CANL common-mode range is ±25V. RXD is a logic-high when CANH and CANL are shorted or terminated and undriven.

Standby Mode

Drive STBY pin high for standby mode, which switches the transmitter off and the receiver to a low current and low-speed state. The supply current is reduced during standby mode. The bus line is monitored by a low differential comparator to detect and recognize a wakeup event on the bus line. Once the comparator detects a dominant bus level greater than 2.3µs typical twaker, RXD pulls low. Drive the STBY low for normal operation.

Slow Slew Rate

Connect a $39.2k\Omega$ resistor between ground and the STBY pin to reduce the slew rate on the transmitter output. The STBY pin voltage should be between 0.1V to 0.6V to remain in slow slew rate. This will change the MAX33040E with a slow slew rate of $15V/\mu s$ for rising edge compared with normal mode at $120V/\mu s$. For falling edge, the slow slew rate is $20V/\mu s$ compared with normal mode at $80V/\mu s$.

Table 1. Transmitter and Receiver Truth Table (When Not Connected to the Bus)

MODE	TXD	TXD LOW TIME	CANH	CANL	BUS STATE	RXD
Normal (STBY = LOW)	LOW	< t _{DOM}	HIGH	LOW	DOMINANT	LOW
Normal (STBY = LOW)	LOW	> t _{DOM}	V _{DD} /2	V _{DD} /2	RECESSIVE	HIGH
Normal (STBY = LOW)	HIGH	X	V _{DD} /2	V _{DD} /2	RECESSIVE	HIGH
Standby (STBY = HIGH)	Х	X	HIGH	LOW	DOMINANT	LOW
Standby (STBY = HIGH)	Х	X	V _{DD} /2	V _{DD} /2	RECESSIVE	HIGH
Shutdown (SHDN = STBY = HIGH)	Х	X	V _{DD} /2	V _{DD} /2	RECESSIVE	HIGH

X = Don't care

Shutdown Mode

Drive SHDN pin high for shutdown mode, which switches the transmitter and receiver off. The supply current is reduced to maximum of 5μ A during shutdown mode. Drive the SHDN pin low for normal operation.

Applications Information

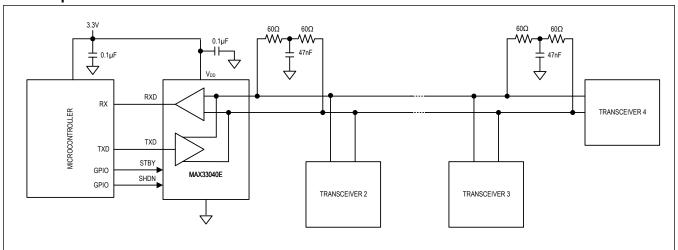
Reduced EMI and Reflections

In multidrop CAN applications, it is important to maintain a single linear bus of uniform impedance that is properly terminated at each end. A star, ring or tree configuration should never be used. Any deviation from the end-to-end wiring scheme creates a stub. High-speed data edges on a stub can create reflections back down to the bus. These reflections can cause data errors by eroding the noise margin of the system.

Although stubs are unavoidable in a multidrop system, care should be taken to keep these stubs as short as possible, especially when operating with high data rates.

Typical Application Circuits

Multidrop CAN Bus



Ordering Information

PART NUMBER	TEMPERATURE RANGE	PIN-PACKAGE
MAX33041EASA+	-40°C to +125°C	8 SO
MAX33041EASA+T	-40°C to +125°C	8 SO
MAX33040EAKA+	-40°C to +125°C	8 SOT23
MAX33040EAKA+T	-40°C to +125°C	8 SOT23
MAX33040EAWA+*	-40°C to +125°C	8 WLP
MAX33040EAWA+T*	-40°C to +125°C	8 WLP

⁺ Denotes a lead(Pb)-free/RoHS-compliant package.

T = Tape and reel.

^{*} Future product—contact factory for availability.

MAX33040E/MAX33041E

+3.3V, 5Mbps CAN Transceiver with ±40V Fault Protection, ±25V CMR, and ±40kV ESD in 8-Pin SOT23

Revision History

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
0	2/20	Initial release	_
1	5/20	Updated General Description, Benefits and Features, Figure 5, Detailed Description, Ordering Information table	1, 12, 19, 21
2	6/21	Updated Ordering Information	17
3	9/21	Updated Electrical Characteristics table	4

